

PRODUCT FEATURES

- ☐ IGBT³ CHIP(Trench+Field Stop technology)
- ☐ High short circuit capability,self limiting short circuit current
- ☐ $V_{CE(sat)}$ with positive temperature coefficient
- ☐ Fast switching and short tail current
- ☐ Free wheeling diodes with fast and soft reverse recovery
- ☐ Low switching losses



APPLICATIONS

- ☐ High frequency switching application
- ☐ Medical applications
- ☐ Motion/servo control
- ☐ UPS systems

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^{\circ}\text{C}$	600	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^{\circ}\text{C}$	240	A
		$T_C=60^{\circ}\text{C}$	200	
I_{CM}	Repetitive Peak Collector Current	$t_p=1\text{ms}$	400	
P_{tot}	Power Dissipation Per IGBT		600	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^{\circ}\text{C}$	600	V
$I_{F(AV)}$	Average Forward Current	$T_C=25^{\circ}\text{C}$	200	A
I_{FRM}	Repetitive Peak Forward Current	$t_p=1\text{ms}$	400	
I^2t		$T_J=125^{\circ}\text{C}$, $t=10\text{ms}$, $V_R=0\text{V}$	3500	A^2S

IGBT-inverter

ELECTRICAL CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V _{GE(th)}	Gate Emitter Threshold Voltage	V _{CE} =V _{GE} , I _C =3.2mA	4.9	5.8	6.5	V
V _{CE(sat)}	Collector Emitter Saturation Voltage	I _C =200A, V _{GE} =15V, T _J =25℃		1.45	1.9	
		I _C =200A, V _{GE} =15V, T _J =125℃		1.6		
I _{CES}	Collector Leakage Current	V _{CE} =600V, V _{GE} =0V, T _J =25℃			1	mA
		V _{CE} =600V, V _{GE} =0V, T _J =125℃			5	mA
I _{GES}	Gate Leakage Current	V _{CE} =0V,V _{GE} =±15V, T _J =25℃	-400		400	nA
R _{gint}	Integrated Gate Resistor			2		Ω
Q _g	Gate Charge	V _{CE} =300V, I _C =200A , V _{GE} =±15V		2.15		μC
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V, f =1MHz		13		nF
C _{res}	Reverse Transfer Capacitance			380		pF
t _{d(on)}	Turn on Delay Time	V _{CC} =300V,I _C =200A R _G =2.0Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		150	ns
			T _J =125℃		160	ns
t _r	Rise Time		T _J =25℃		30	ns
			T _J =125℃		40	ns
t _{d(off)}	Turn off Delay Time	V _{CC} =300V,I _C =200A R _G =2.0Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		340	ns
			T _J =125℃		370	ns
t _f	Fall Time		T _J =25℃		60	ns
			T _J =125℃		70	ns
E _{on}	Turn on Energy	V _{CC} =300V,I _C =200A R _G =2.0Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		1	mJ
			T _J =125℃		1.55	mJ
E _{off}	Turn off Energy		T _J =25℃		5.65	mJ
			T _J =125℃		6.90	mJ
I _{sc}	Short Circuit Current	tpsc≤6μS , V _{GE} =15V T _J =125℃,V _{CC} =360V		1000		A
R _{thJC}	Junction to Case Thermal Resistance （ Per IGBT ）				0.25	K /W

Diode-inverter

ELECTRICAL CHARACTERISTICS

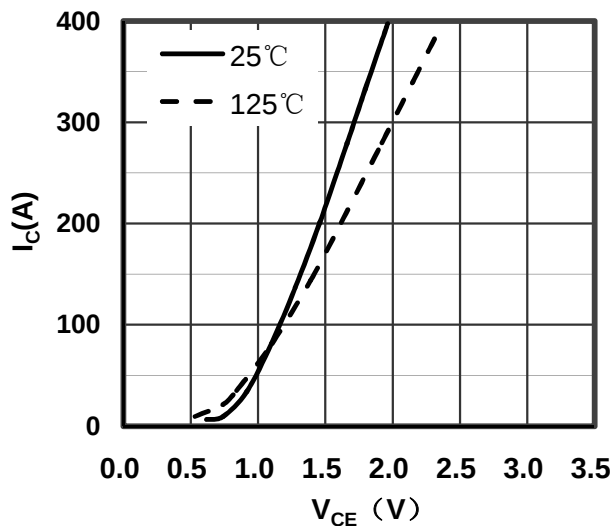
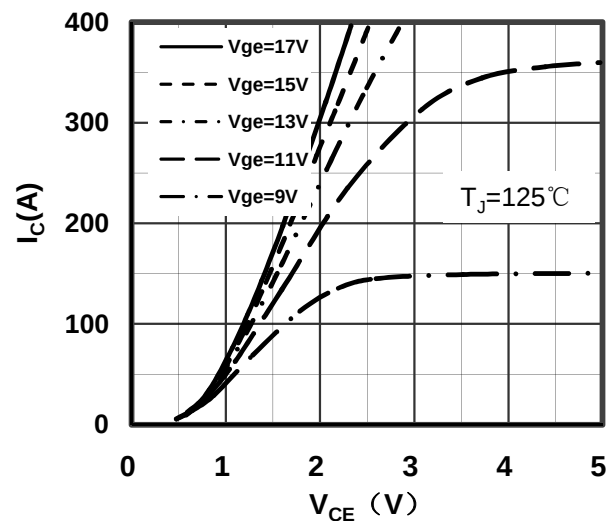
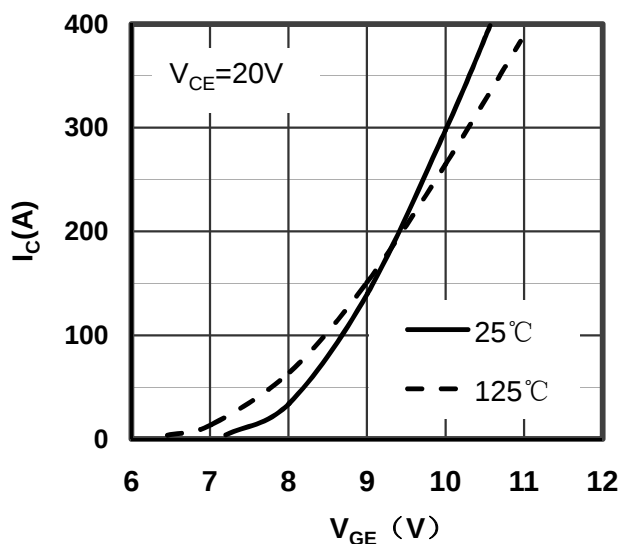
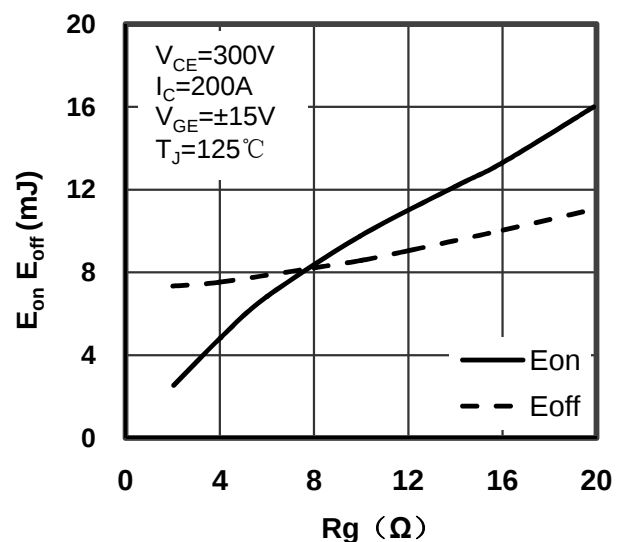
 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V _F	Forward Voltage	I _F =200A , V _{GE} =0V, T _J =25°C		1.55	1.95	V
		I _F =200A , V _{GE} =0V, T _J =125°C		1.50		
t _{rr}	Reverse Recovery Time	I _F =200A , V _R =300V di _F /dt=-5700A/μs T _J =125°C		170		ns
I _{RRM}	Max. Reverse Recovery Current			230		A
Q _{RR}	Reverse Recovery Charge			17		μC
E _{rec}	Reverse Recovery Energy			5.2		mJ
R _{thJCD}	Junction to Case Thermal Resistance （ Per Diode ）				0.45	K /W

MODULE CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature		175	$^\circ\text{C}$
T_{Jop}	Operating Temperature		-40~150	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 200	
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M5)	2.5~5	Nm
Weight			160	g

Figure 1. Typical Output Characteristics
IGBT-inverterFigure 2. Typical Output Characteristics
IGBT-inverterFigure 3. Typical Transfer Characteristics
IGBT-inverterFigure 4. Switching Energy vs Gate Resistor
IGBT-inverter

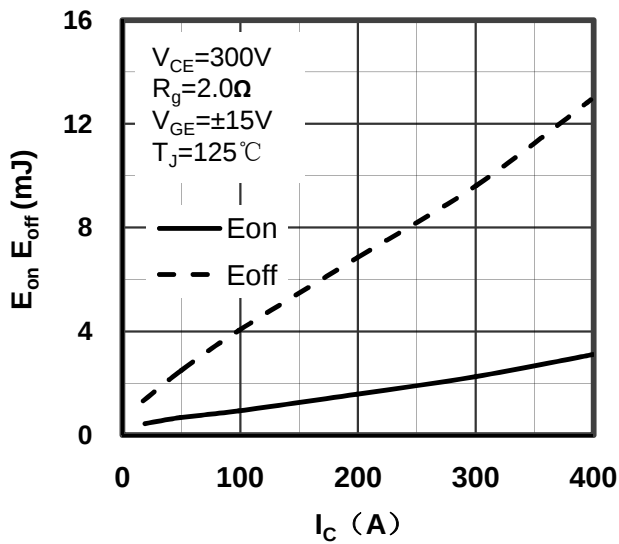


Figure 5. Switching Energy vs Collector Current IGBT-inverter

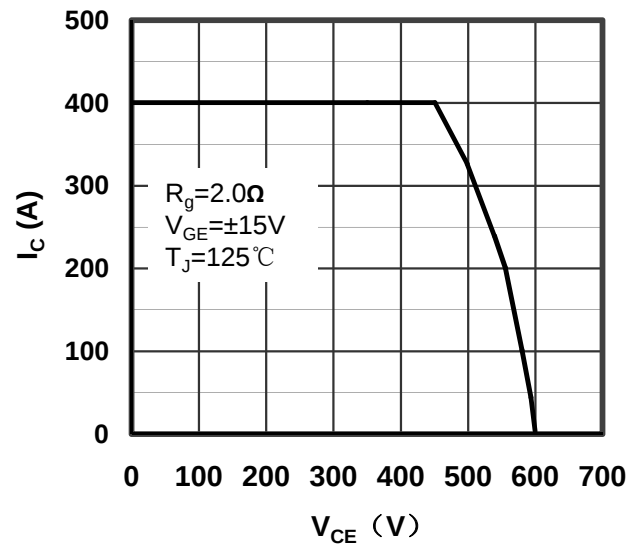


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

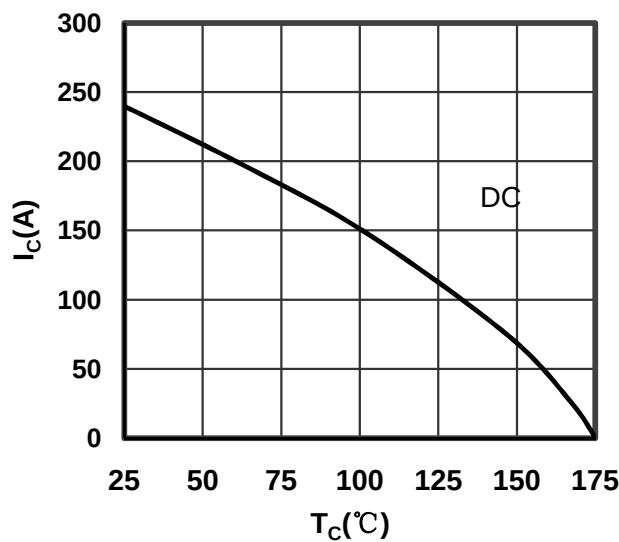


Figure 7. Collector Current vs Case temperature IGBT-inverter

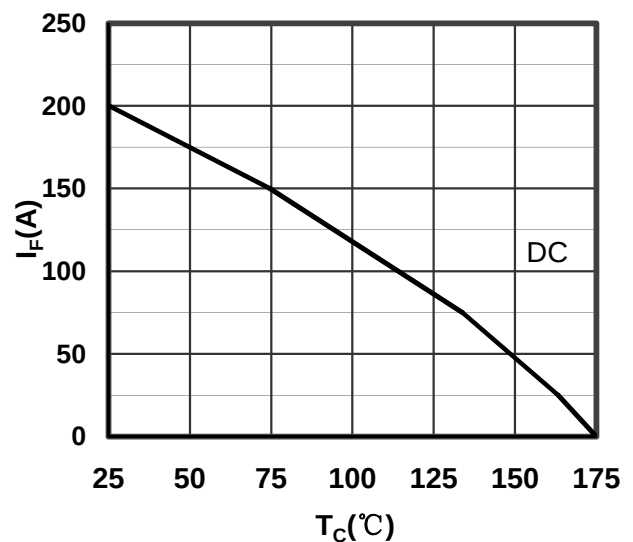


Figure 8. Forward current vs Case temperature Diode-inverter

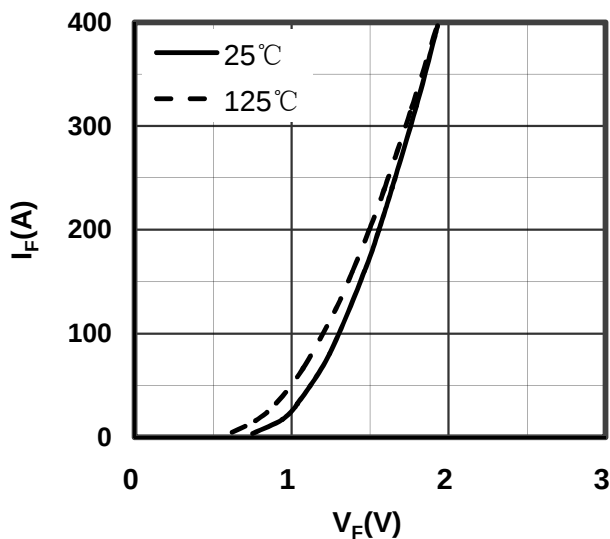


Figure 9. Diode Forward Characteristics Diode-inverter

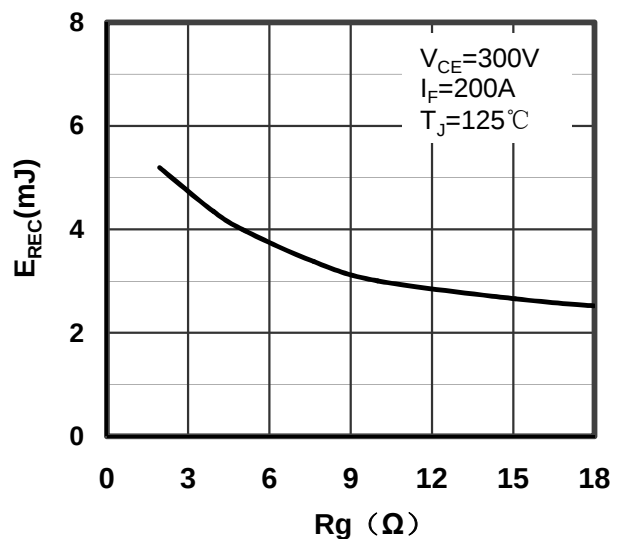


Figure 10. Switching Energy vs Gate Resistor Diode-inverter

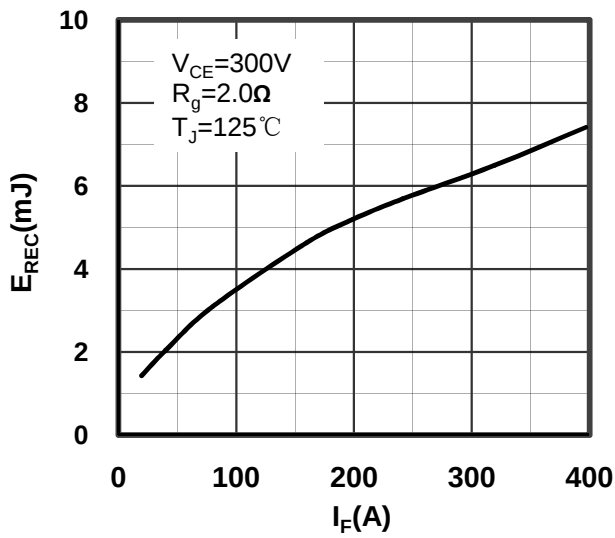


Figure 11. Switching Energy vs Forward Current Diode-inverter

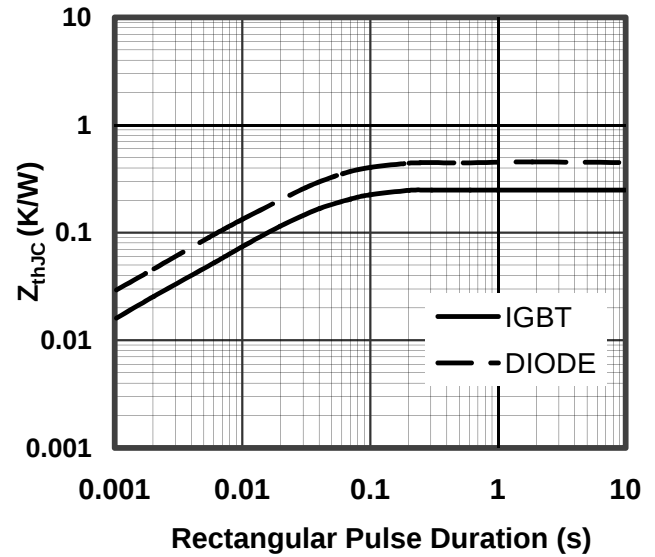


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

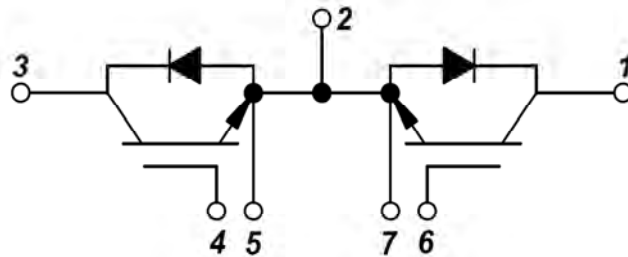
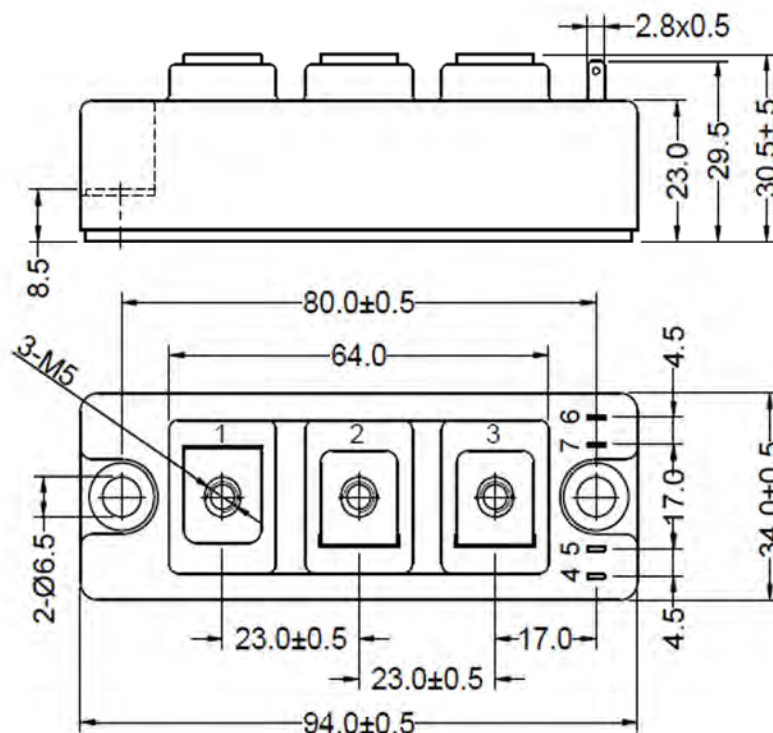


Figure 13. Circuit Diagram



Dimensions in (mm)
Figure 14. Package Outline